



100 V, 1 A PNP low V<sub>CEsat</sub> (BISS) transistor Rev. 03 — 22 November 2009

Product data sheet

#### **Product profile** 1.

#### 1.1 General description

PNP low V<sub>CEsat</sub> transistor in a SOT54 (SC-43/TO-92) plastic package.

#### **1.2 Features**

- SOT54 package
- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability I<sub>C</sub> and I<sub>CM</sub>
- High efficiency leading to less heat generation

#### 1.3 Applications

- Major application segments:
  - Automotive 42 V power
  - Telecom infrastructure
  - Industrial
- Peripheral driver:
  - Driver in low supply voltage applications (e.g. lamps and LEDs)
  - Inductive load driver (e.g. relays, buzzers and motors)
- DC-to-DC converter

### 1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage		-	-	-100	V
I <sub>C</sub>	collector current (DC)		-	-	-1	А
I <sub>CM</sub>	peak collector current		-	-	-3	А
R <sub>CEsat</sub>	equivalent on-resistance		-	-	320	mΩ



# 2. Pinning information

Table 2.	Discrete pinning		
Pin	Description	Simplified outline	Symbol
1	base		
2	collector		2
3	emitter		
		321	sym029

# 3. Ordering information

Table 3.         Ordering information					
Type number	Package				
	Name	Description	Version		
PBSS9110S	-	plastic single-ended leaded (through hole) package; 3 leads	SOT54		

# 4. Marking

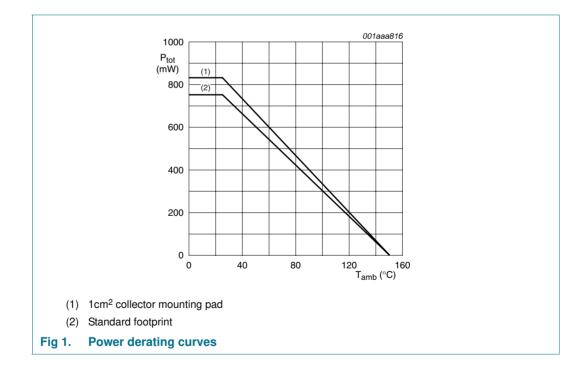
Table 4. Marking	
Type number	Marking code
PBSS9110S	S9110S[1]

[1] Made in China

# 5. Limiting values

Table 5. In accorda	Limiting values nce with the Absolute Maximun	n Rating System (IEC	60134).		
Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	-120	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-100	V
$V_{\text{EBO}}$	emitter-base voltage	open collector	-	-5	V
I <sub>CM</sub>	peak collector current	T <sub>j(max)</sub>	-	-3	А
I <sub>C</sub>	collector current (DC)		-	-1	А
I <sub>B</sub>	base current (DC)		-	-0.3	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>1]</u> -	830	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

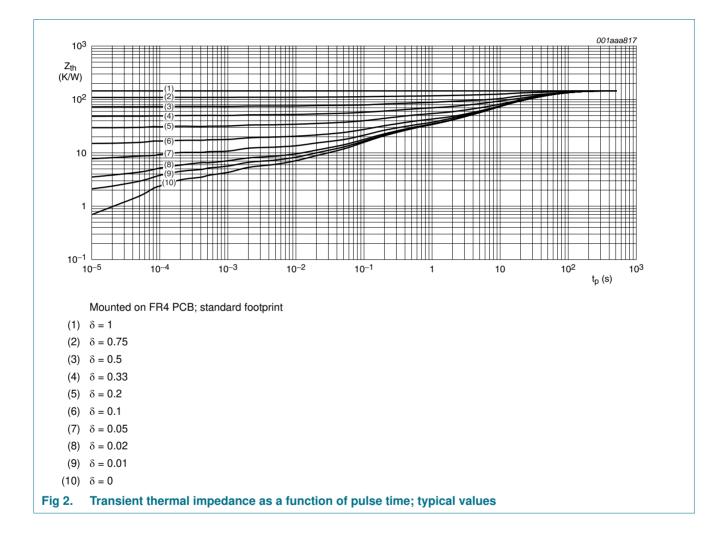
[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, standard footprint.



# 6. Thermal characteristics

Table 6.	Thermal characteristics				
Symbol	Parameter	Conditions		Тур	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u>	150	K/W

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, standard footprint.



## 7. Characteristics

#### Table 7.Characteristics

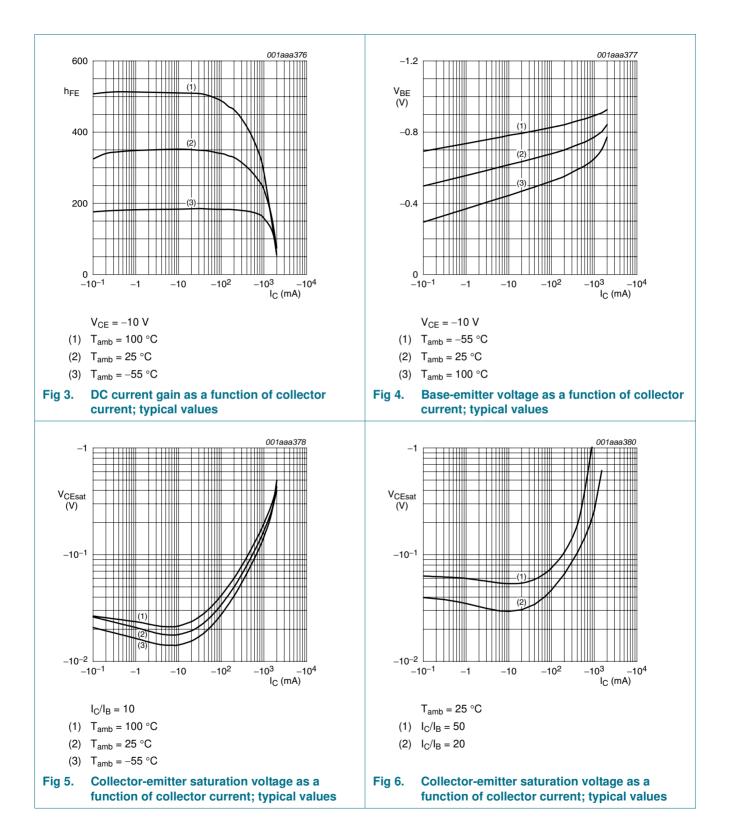
 $T_{amb} = 25$  °C unless otherwise specified.

				Тур	Max	Unit
collector-base cut-off	$V_{CB} = -80 \text{ V}; I_E = 0 \text{ A}$		-	-	-100	nA
current	$\label{eq:VCB} \begin{array}{l} V_{CB} = -80 \ V; \ I_E = 0 \ A; \\ T_j = 150 \ ^\circ C \end{array}$		-	-	-50	μA
collector-emitter cut-off current	$V_{CE} = -80 \text{ V};  V_{BE} = 0 \text{ V}$		-	-	-100	nA
emitter-base cut-off current	$V_{EB} = -4 \text{ V}; \text{ I}_{C} = 0 \text{ A}$		-	-	-100	nA
DC current gain	$V_{CE} = -5 \text{ V}; I_C = -1 \text{ mA}$		150	-	-	
	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -250 \text{ mA}$		150	-	-	
	$V_{CE}$ = $-5$ V; $I_{C}$ = $-0.5$ A	[1]	150	-	450	
	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	[1]	125	-	-	
collector-emitter saturation voltage	$I_{C} = -250 \text{ mA}; I_{B} = -25 \text{ mA}$		-	-	-120	mV
	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}$		-	-	-180	mV
	$I_{C} = -1 \text{ A}; I_{B} = -100 \text{ mA}$		-	-	-320	mV
equivalent on-resistance	$I_{C} = -1 \text{ A}; I_{B} = -100 \text{ mA}$	<u>[1]</u>	-	170	320	mΩ
base-emitter saturation voltage	$I_{C} = -1 \text{ A}; I_{B} = -100 \text{ mA}$		-	-	-1.1	V
base-emitter turn-on voltage	$I_{C} = -1 \text{ A}; V_{CE} = -5 \text{ V}$		-	-	-1.0	V
transition frequency	$I_{C} = -50 \text{ mA}; V_{CE} = -10 \text{ V};$ f = 100 MHz		100	-	-	MHz
collector capacitance	$  I_E = I_e = 0 \text{ A};  V_{CB} = -10 \text{ V}; $ f = 1 MHz		-	-	17	pF
	collector-emitter cut-off currentemitter-base cut-off currentDC current gainDC current gaincollector-emitter saturation voltageequivalent on-resistancebase-emitter saturation voltagebase-emitter saturation voltagebase-emitter turn-on voltagetransition frequency	$v_{CB} = -80 \text{ V}, i_E = 0 \text{ A}, \\ T_j = 150 \text{ °C}$ collector-emitter cut-off current $V_{CE} = -80 \text{ V}; V_{BE} = 0 \text{ V}$ emitter-base cut-off current $V_{CE} = -4 \text{ V}; i_C = 0 \text{ A}$ $V_{CE} = -5 \text{ V}; i_C = -1 \text{ mA}$ $V_{CE} = -5 \text{ V}; i_C = -250 \text{ mA}$ $V_{CE} = -5 \text{ V}; i_C = -0.5 \text{ A}$ $V_{CE} = -5 \text{ V}; i_C = -1 \text{ A}$ $V_{CE} = -5 \text{ V}; i_C = -1 \text{ A}$ $I_C = -250 \text{ mA}; i_B = -25 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ equivalent on-resistance $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$	$v_{CB} = -80 \text{ V}, i_E = 0 \text{ A}, \\ T_j = 150 \text{ °C}$ collector-emitter cut-off current $V_{CE} = -80 \text{ V}; V_{BE} = 0 \text{ V}$ emitter-base cut-off current $V_{CE} = -4 \text{ V}; i_C = 0 \text{ A}$ $V_{CE} = -5 \text{ V}; i_C = -1 \text{ mA}$ $V_{CE} = -5 \text{ V}; i_C = -1 \text{ mA}$ $V_{CE} = -5 \text{ V}; i_C = -250 \text{ mA}$ $V_{CE} = -5 \text{ V}; i_C = -0.5 \text{ A}$ $U_{CE} = -5 \text{ V}; i_C = -1 \text{ A}$ $U_{CE} = -5 \text{ V}; i_C = -1 \text{ A}$ $U_{CE} = -5 \text{ V}; i_C = -1 \text{ A}$ $U_{CE} = -5 \text{ V}; i_C = -1 \text{ A}$ $U_{CE} = -5 \text{ V}; i_C = -1 \text{ A}$ $U_{CE} = -50 \text{ mA}; i_B = -25 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $I_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -1 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -10 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -10 \text{ A}; i_B = -100 \text{ mA}$ $U_C = -10 \text{ A}; i_B = -100 \text{ mA}$	$\begin{array}{c c c c c c } V_{CB} = -30 \text{ V}, \text{ I}_E = 0 \text{ A}, & & -\\ T_j = 150 \ ^{\circ}\text{C} & & & \\ \hline T_j = 150 \ ^{\circ}\text{C} & & & \\ \hline Collector-emitter \\ cut-off current & & & \\ V_{CE} = -80 \text{ V}; \text{ V}_{BE} = 0 \text{ V} & & -\\ \hline emitter-base cut-off \\ current & & & \\ V_{CE} = -5 \text{ V}; \text{ I}_C = 0 \text{ A} & & -\\ \hline DC \text{ current gain} & & & \\ V_{CE} = -5 \text{ V}; \text{ I}_C = -1 \text{ mA} & & 150 \\ \hline V_{CE} = -5 \text{ V}; \text{ I}_C = -250 \text{ mA} & & 150 \\ \hline V_{CE} = -5 \text{ V}; \text{ I}_C = -0.5 \text{ A} & & \text{II} & 150 \\ \hline V_{CE} = -5 \text{ V}; \text{ I}_C = -1 \text{ A} & & \text{II} & 125 \\ \hline collector-emitter \\ saturation voltage & & \\ I_C = -250 \text{ mA}; \text{ I}_B = -25 \text{ mA} & -\\ I_C = -500 \text{ mA}; \text{ I}_B = -25 \text{ mA} & -\\ I_C = -1 \text{ A}; \text{ I}_B = -100 \text{ mA} & -\\ \hline I_C = -1 \text{ A}; \text{ I}_B = -100 \text{ mA} & -\\ \hline equivalent \\ on-resistance & & \\ I_C = -1 \text{ A}; \text{ I}_B = -100 \text{ mA} & -\\ \hline base-emitter \\ saturation voltage & & \\ I_C = -1 \text{ A}; \text{ I}_B = -100 \text{ mA} & -\\ \hline base-emitter \\ saturation voltage & & \\ I_C = -1 \text{ A}; \text{ I}_B = -100 \text{ mA} & -\\ \hline current \\ $	$ \begin{array}{c c c c c c } V_{CB} = -30 \ V, \ IE = 0 \ A, \\ T_{j} = 150 \ ^{\circ}C \ \\ \hline T_{j} = 150 \ ^{\circ}C \ \\ \hline T_{j} = 150 \ ^{\circ}C \ \\ \hline V_{CE} = -80 \ V; \ V_{BE} = 0 \ V \ \\ - & - \ \\ \hline \end{array} \\ \hline \begin{array}{c c c c c } current \ \\ \hline \end{array} \\ \hline \end{array} \\ \hline \begin{array}{c c c c c c } current \ \\ \hline \end{array} \\ \hline \end{array} \\ \hline \begin{array}{c c c c c c } current \ \\ \hline \end{array} \\ \hline \end{array} \\ \hline \begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

[1] Pulse test:  $t_p \le 300 \ \mu s; \delta \le 0.02$ .

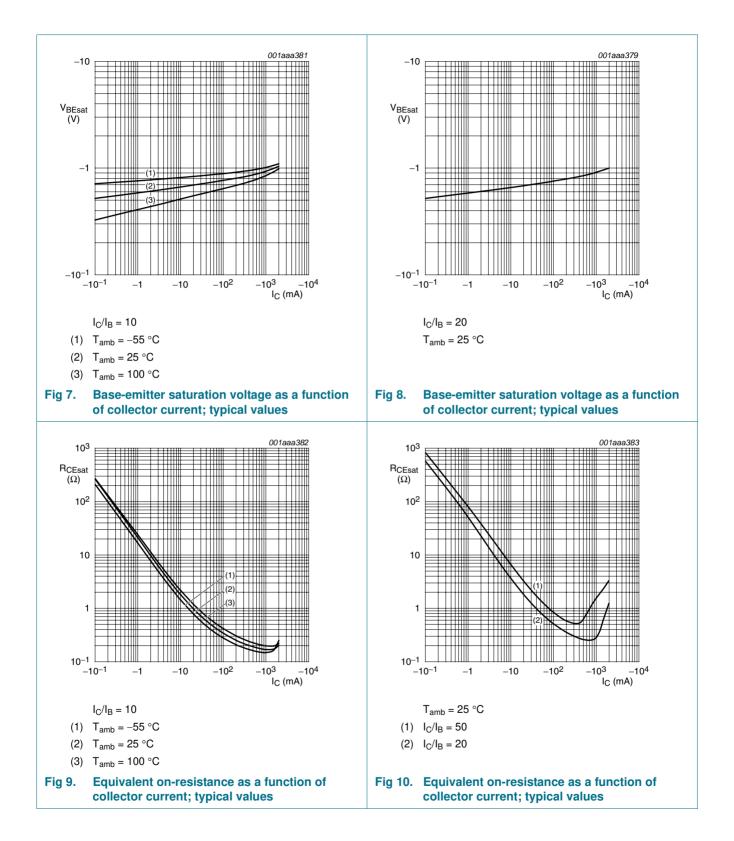
# **PBSS9110S**

#### 100 V, 1 A PNP low V<sub>CEsat</sub> (BISS) transistor

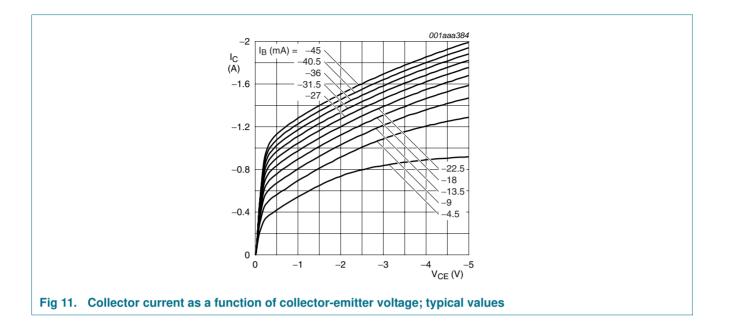


# **PBSS9110S**

#### 100 V, 1 A PNP low V<sub>CEsat</sub> (BISS) transistor

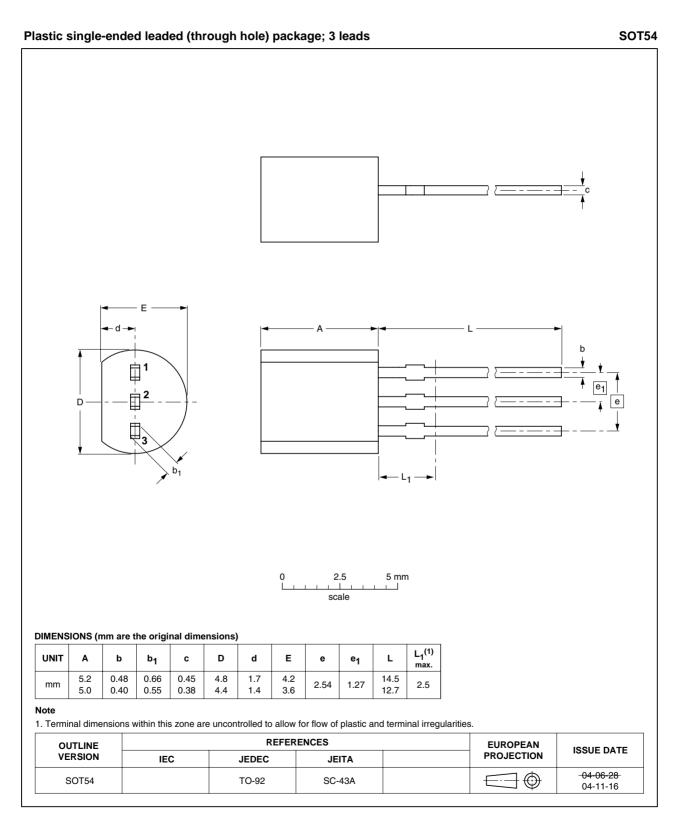


**PBSS9110S** 



**PBSS9110S** 

### 8. Package outline



#### Fig 12. Package outline

# 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
PBSS9110S_3	20091122	Product data sheet	-	PBSS9110S_2		
Modifications:		eet was changed to reflect v legal definitions and disc				
	<u>Table 2 "Discrete pinning"</u> : amended					
	• Figure 9 "Equivalent on-resistance as a function of collector current; typical values": updated					
	• Figure 10 "Equivalent on-resistance as a function of collector current; typical values": updated					
	• Figure 11 "Collector current as a function of collector-emitter voltage; typical values": updated					
	• Figure 12 "Pa	ackage outline": updated				
PBSS9110S_2	20040810	Product data	-	PBSS9110S_1		
PBSS9110S 1	20040607	Product data	-	_		

# 10. Legal information

#### 10.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### 10.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

#### **10.3 Disclaimers**

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

#### 10.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

# 11. Contact information

For more information, please visit: <u>http://www.nxp.com</u> For sales office addresses, please send an email to: <u>salesaddresses@nxp.com</u>

## 12. Contents

1	Product profile 1
1.1	General description 1
1.2	Features
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 4
7	Characteristics 5
8	Package outline 9
9	Revision history 10
10	Legal information 11
10.1	Data sheet status 11
10.2	Definitions 11
10.3	Disclaimers
10.4	Trademarks 11
11	Contact information 11
12	Contents 12

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

#### © NXP B.V. 2009.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

to: salesaddresses@nxp.com Date of release: 22 November 2009 Document identifier: PBSS9110S\_3

All rights reserved.



PHILIPS